

C3M0021120K1

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- Optimized package with separate driver source pin
- Lower profile TO-247-4 package body
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

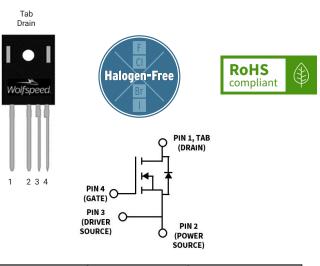
- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters
- Solar/ESS
- UPS
- Enterprise PSU

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			1200		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
				104		$V_{GS} = 15 V, T_{C} = 25 °C, T_{J} \le 175 °C$	Fig. 19
DC Continuous Drain Current	I _D			75	A	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	Note 2
Pulsed Drain Current	I _{DM}			248		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{c} = 25 °C$	Fig. 22
Power Dissipation	P _D			405	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-55 to +175	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Package



Part Number	Package	Marking
C3M0021120K1	TO-247-4L LP	C3M0021120K1

C3M0021120K1

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V _{(BR)DSS}	Drain-Source Breakdown Voltage	1200			V	V _{GS} = 0 V, I _D = 100 μA	
		1.8	2.9	3.8	V	V _{DS} = V _{GS} , I _D = 17.1 mA	Fig. 11
$V_{\text{GS(th)}}$	Gate Threshold Voltage		2.3		V	V _{DS} = V _{GS} , I _D = 17.1 mA, T _J = 175°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V _{DS} = 1200 V, V _{GS} = 0 V	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
R _{DS(on)}	Drain-Source On-State Resistance		21	29	mΩ	V _{GS} = 15 V, I _D = 62.1 A	Fig. 4, 5, 6
DS(on)			35		11152	V _{GS} = 15 V, I _D = 62.1 A, T _J = 175°C	
g _{fs}	Transconductance		38		s	V _{DS} = 20 V, I _{DS} = 62.1 A	Fig. 7
915			35			V _{DS} = 20 V, I _{DS} = 62.1 A, T _J = 175°C	
C _{iss}	Input Capacitance		5100				
C_{oss}	Output Capacitance		174		pF	V_{GS} = 0 V, V_{DS} = 0V to 1000 V	Fig. 17, 18
C _{rss}	Reverse Transfer Capacitance		11			F = 100 kHz Vac = 25 mV	
E _{oss}	C _{oss} Stored Energy		98		μJ	VAC = 25 IIIV	Fig. 16
C _{o(er)}	Effective Output Capacitance (Energy Related)		210		pF	V _{GS} = 0 V, V _{DS} = 0 800V	Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		323		pF		
Eon	Turn-On Switching Energy (External Diode)		0.96			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 62.12 A,	Fig. 26, 28
EOFF	Turn Off Switching Energy (External Diode)		0.45		mJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 µH, T _J = 175°C FWD = External SiC DIODE	
Eon	Turn-On Switching Energy (Body Diode FWD)		1.99			V _{DS} = 800 V, V _{GS} = -4 V/15 V, I _D = 62.12 A,	Fig. 26, 28
EOFF	Turn-Off Switching Energy (Body Diode FWD)		0.43		mJ	$R_{G(ext)} = 2.5 \Omega$, L= 59 μH, T _J = 175°C FWD = Internal Body Diode	
t _{d(on)}	Turn-On Delay Time		17				
tr	Rise Time		39]	$\label{eq:VDD} \begin{split} V_{\text{DD}} &= 800 \text{ V}, V_{\text{GS}} = -4 \text{ V}/15 \text{ V} \\ I_{\text{D}} &= 62.12 \text{ A}, R_{\text{G(ext)}} = 2.5 \Omega, \\ \text{Timing relative to } V_{\text{DS}} \\ \text{Inductive load} \end{split}$	Fig. 27, 28
$t_{\text{d(off)}}$	Turn-Off Delay Time		54		ns		
t _f	Fall Time		13				
R _{G(int)}	Internal Gate Resistance		3		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		59			V _{DS} = 800 V, V _{GS} = -4 V/15 V	Fig. 12
Q_{gd}	Gate to Drain Charge		53		nC	$I_{\rm D} = 62.12 \text{A}$	
Qg	Total Gate Charge	I T	177			Per IEC60747-8-4 pg 21	

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): Co(er), a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V Co(tr), a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V



Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
N		4.9		V	V _{GS} = -4 V, I _{SD} = 31.1 A, T _J = 25 °C	Fig. 8,
V_{SD}	Diode Forward Voltage	4.4		V	V _{GS} = -4 V, I _{SD} = 31.1 A, T _J = 175 °C	9, 10
ls	Continuous Diode Forward Current		73	А	$V_{gs} = -4 V$, $T_c = 25^{\circ}C$	
I _{sм}	Diode pulse Current		248	А	$V_{_{GS}}$ = -4 V, pulse width $t_{\rm p}$ limited by T_{jmax}	
t _{rr}	Reverse Recover time	30		ns		
Q _{rr}	Reverse Recovery Charge	1264		nC	V _{GS} = -4 V, I _{SD} = 62.1 A, V _R = 800 V dif/dt = 4845 A/μs, Τ _J = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	64		А		
t _{rr}	Reverse Recover time	45		ns		
Q _{rr}	Reverse Recovery Charge	1050		nC	V _{GS} = -4 V, I _{SD} = 62.1 A, V _R = 800 V dif/dt = 2415 A/μs, Τ, = 175 °C	
l _{rrm}	Peak Reverse Recovery Current	13		А		

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
R _{eJC}	Thermal Resistance from Junction to Case	0.28	°C/W		Fig. 21



Typical Performance

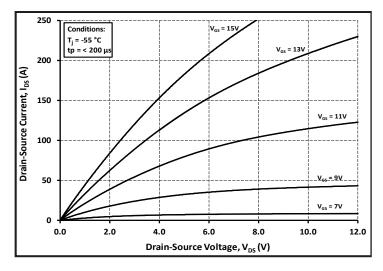
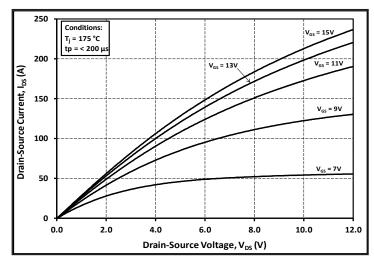
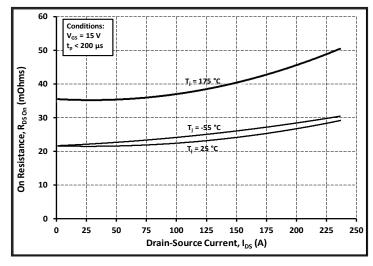
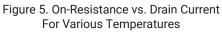


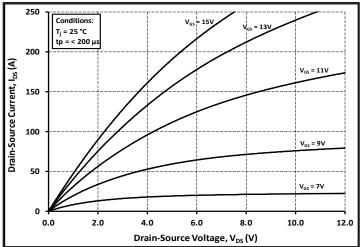
Figure 1. Output Characteristics T_J = -55 °C



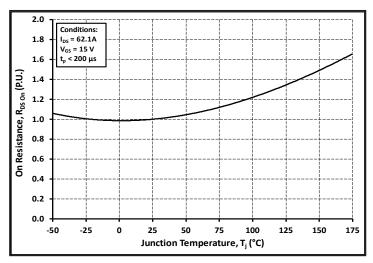














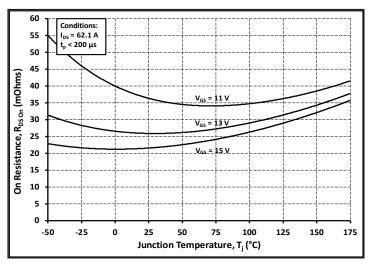


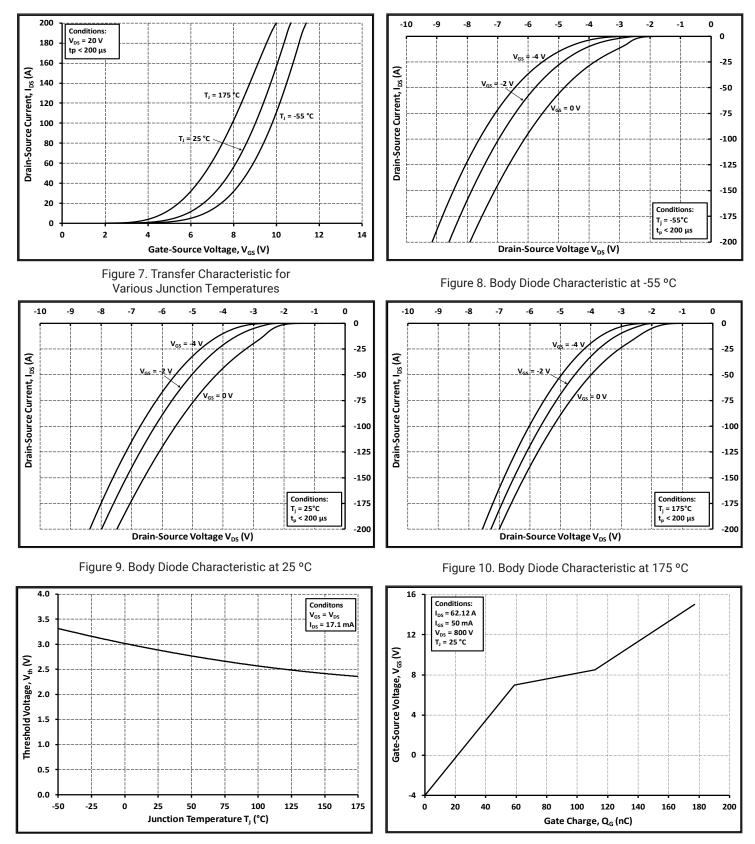
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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Typical Performance



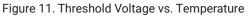


Figure 12. Gate Charge Characteristics

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Typical Performance

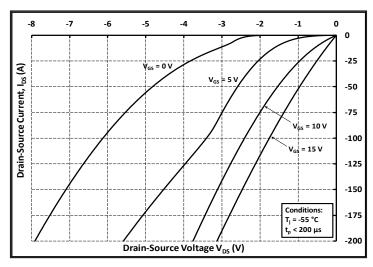


Figure 13. 3rd Quadrant Characteristic at -55 °C

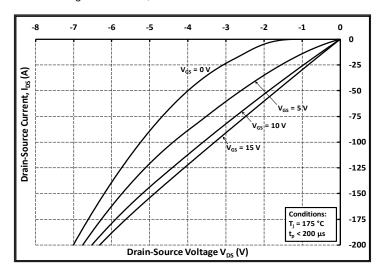
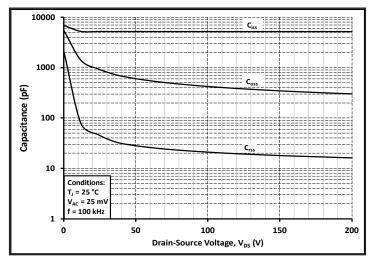
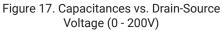


Figure 15. 3rd Quadrant Characteristic at 175 °C





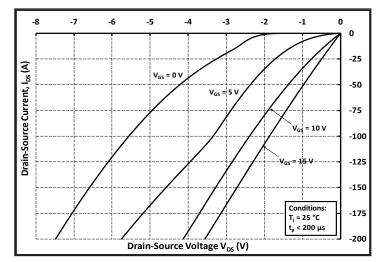


Figure 14. 3rd Quadrant Characteristic at 25 °C

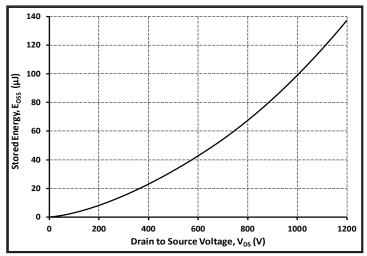


Figure 16. Output Capacitor Stored Energy

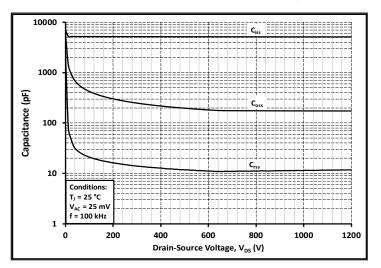
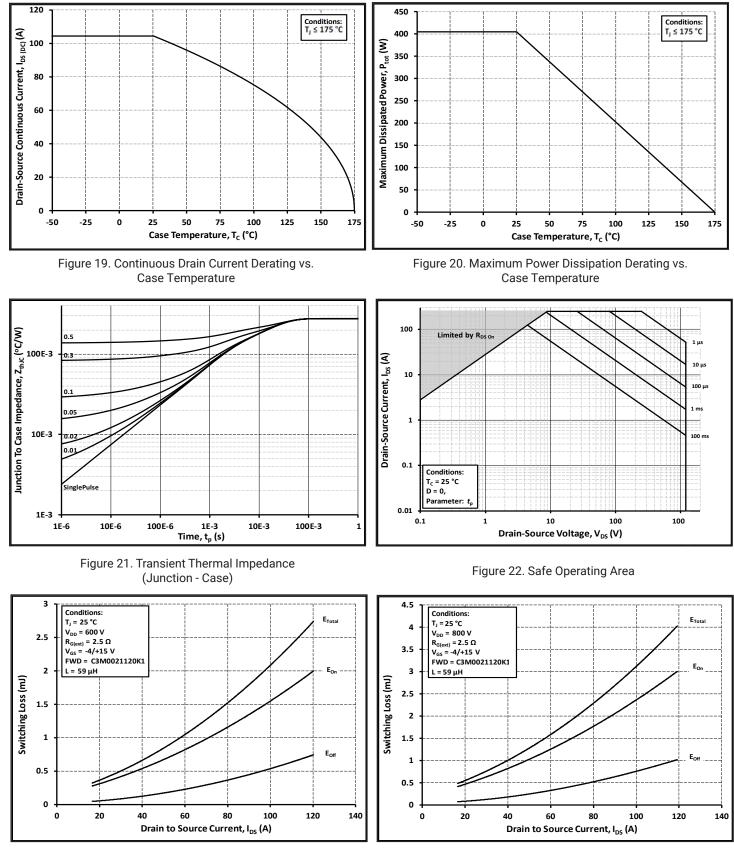


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

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Typical Performance



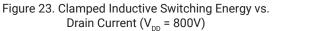


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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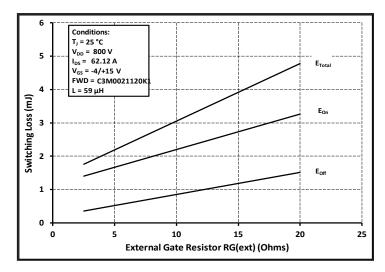


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

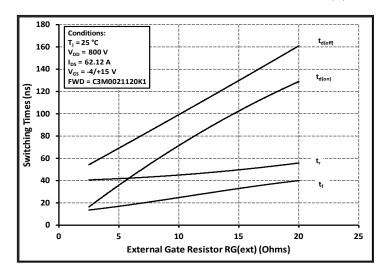


Figure 27. Switching Times vs. R_{G(ext)}

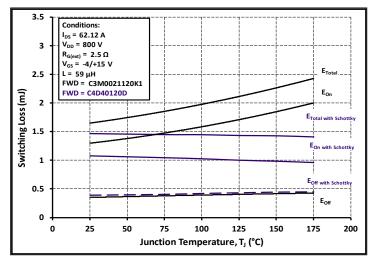


Figure 26. Clamped Inductive Switching Energy vs. Temperature

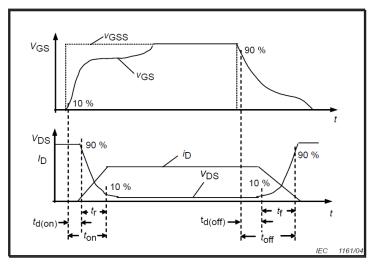


Figure 28. Switching Times Definition

Test Circuit Schematic



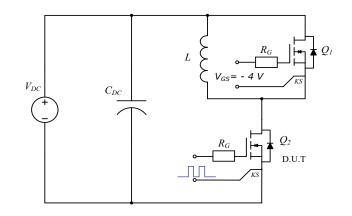


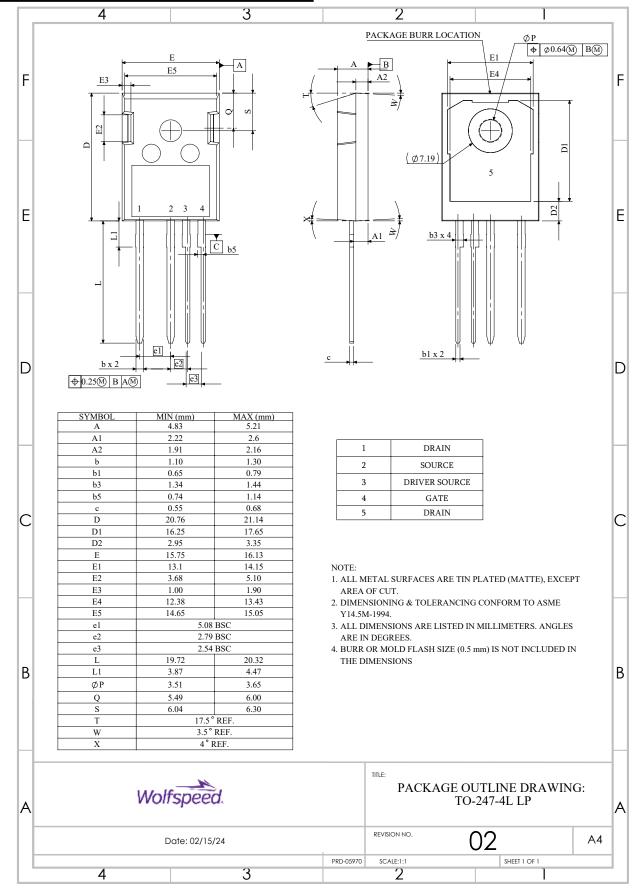
Figure 29. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions



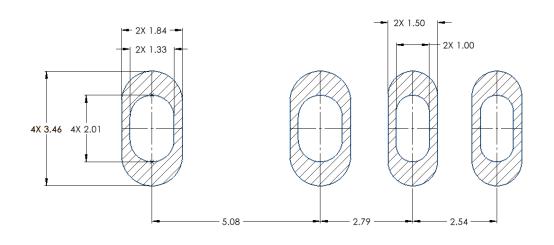
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Recommended Solder Pad Layout

All dimensions in mm



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Revision history

Document Version	Date of release	Descriptiion of changes
1.0	April-2024	Initial datasheet
2.0	October - 2024	Legal Disclaimer

Rev. 2, October 2024



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